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May 2011

FAN256 — Dual Low Voltage Comparator

Features

- Low Supply Current: I_{DD}=7µA (Typical)
- Single Power Supply Operation
- Wide Common-Mode Input Voltage Range: Rail-to-Rail
- Push-Pull Output Circuit
- Low Input Bias Current
- Internal Hysteresis
- Packaged in MicroPak™ 8 (1.6mm x 1.6mm)

Applications

- Mobile Phones
- Alarm and Security Systems
- Personal Digital Assistants

Description

The FAN256 is a low-power, dual comparator that typically consumes less than $10\mu A$ supply current per comparator. Guaranteed to operate at a low voltage of 1.6V and fully operational up to 5.5V, it is convenient for use in 1.8, 3.0V, and 5.0V systems.

The FAN256 has a complementary push-pull P- and N-channel output stage capabile of driving a rail-to-rail output swing with a load ranging up to 5.0mA.

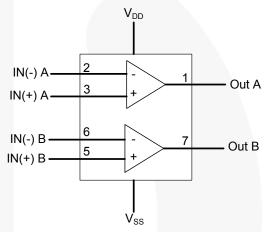


Figure 1. Functional Diagram

Ordering Information

Part Number	Number Top Mark Temperature Range		Package	Packing Method	
FAN256L8X	N256L8X		8-Lead, MicroPak™ 1.6mm x 1.6mm Package	5000 Units on Tape and Reel	

Pin Configuration

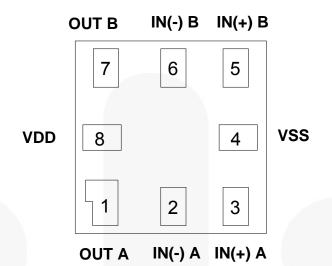


Figure 2. Pin Configuration (Top Through View)

Pin Definitions

Pin#	Name	Description		
1	OUT A	Comparator A Output		
2	IN(-) A	Inverting Input of Comparator A		
3	IN(+) A	Non-Inverting Input of Comparator A		
4	VSS	Negative Supply Voltage		
5	IN(+) B	on-Inverting Input of Comparator B		
6	IN(-) B	Inverting Input of Comparator B		
7	OUT B	Comparator B Output		
8	VDD	Positive Supply Voltage		

Function Table

Inputs	Outputs
IN(-) > IN(+)	Output LOW
IN(+) > IN(-)	Output HIGH

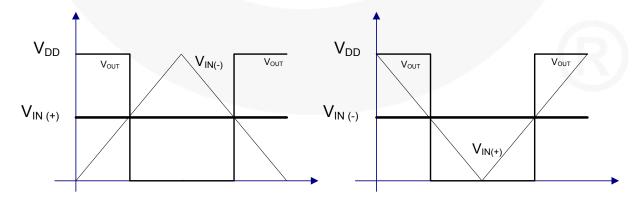


Figure 3. V_{IN} vs. V_{OUT}

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Condition	Min.	Max.	Unit	
\/ to\/	Supply Voltage		-3.0	+3.0	V	
V_{DD} to V_{SS}	Supply Voltage		0	6.0	V	
DV _{IN}	Differential Input Voltage			±6		
V _{IN}	Input Voltage			V _{SS} to V _{DD}	V	
ts	Output Short Circuit Duration ⁽¹⁾			Indefinite	S	
TJ	Junction Temperature			+150	°C	
T _{STG}	Storage Temperature Range		-65	+150	°C	
P _D	Power Dissipation			226	mW	
Θ_{JA}	Thermal Resistance			287	°C/W	
	IFC 61000 4 2 System FSD	Air Gap		15		
	IEC 61000-4-2 System ESD	Contact		8		
	IEDEC IESD22 A444 Human Bady	All Pins		8		
ESD	JEDEC JESD22-A114, Human Body Model	Pin to Pin: IN(-), IN(+) to V _{DD} or V _{SS}		12	kV	
	JEDEC JESD22-C101, Charged Device Model	All Pins		2		

Note:

1. The maximum total power dissipation must not be exceeded.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Condition	Min.	Max.	Unit
\/ to\/	Dower Cumply		-2.75	+2.75	V
V _{DD} to V _{SS}	Power Supply		0	5.5	V
V_{DD}	Power Supply	V _{SS} =0V	1.6	5.5	V
V_{IN}	Input Voltage			V_{SS} to V_{DD}	V
		V _{DD} =5.0V		5	
I _{OH} /I _{OL}	Output Sink/Source Current	V _{DD} =3.0V		3	mA
		V _{DD} =1.6V		1	
T _A	Operating Temperature, Free Air		-40	+85	°C

Electrical Characteristics

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit	
V _{DD} =5.5V, V ₅	_{SS} =GND, and T _A =+25°C	•	•				
V _{HYS}	Input Hysteresis	V _{CM} =0.5V _{DD}		4		mV	
V _{IO}	Input Offset Voltage ⁽²⁾	V _{CM} =0.5V _{DD}	-15	±1	+15	mV	
I _{IO}	Input Offset Current			10		pА	
II	Input Bias Current			10		pА	
V _{CM}	Common Mode Input Voltage		V _{SS}		V_{DD}	V	
CMRR	Common Mode Rejection Ratio ⁽³⁾	V _{CM} =V _{DD}		68		dB	
I _{DD}	Supply Current - Per Comparator			7	17	μA	
PSRR	Power Supply Rejection Ratio ⁽³⁾	ΔV_{DD} =0.5V	45	80		dB	
	Outside Object Object Outside	V _O =V _{DD}		60		0	
I _{OS}	Output Short Circuit Current	V _O =V _{SS}		90		mA	
V _{OL}	Low-Level Output Voltage	I _{SINK} =5.0mA		0.1	0.3	V	
V _{OH}	High-Level Output Voltage	I _{SOURCE} =5.0mA	5.2	5.4		V	
t _{PLH}	Propagation Delay (Turn-On)	Overdrive=20mV, C _L =15pF		0.40		μs	
t _{PHL}	Propagation Delay (Turn-Off)	Overdrive=20mV, C _L =15pF		0.42		μs	
t _{TLH}				4.0			
t _{THL}	Response Time, Output Rise/Fall ⁽⁴⁾	C _L =50pF		5.4		ns	
V _{DD} =3V, V _{SS} :	=GND, and T _A =+25°C		4		•		
V _{HYS}	Input Hysteresis	V _{CM} =0.5V _{DD}		4		mV	
V _{IO}	Input Offset Voltage ⁽²⁾	V _{CM} =0.5V _{DD}	-15	±1	+15	mV	
I _{IO}	Input Offset Current			10		pА	
I _I	Input Bias Current			10		pА	
V_{CM}	Common Mode Input Voltage		V _{SS}		V_{DD}	V	
CMRR	Common Mode Rejection Ratio ⁽³⁾	V _{CM} =V _{DD}		60		dB	
I _{DD}	Supply Current(x) Per Comparator			6	15	μΑ	
PSRR	Power Supply Rejection Ratio ⁽³⁾	ΔV_{DD} =0.5V	45	70		dB	
	Outside Object Object Outside	V _O =V _{DD}	///	27	y		
los	Output Short Circuit Current	V _O =V _{SS}		35	У	mA	
V _{OL}	Low-Level Output Voltage	I _{SINK} =3.0mA		0.15	0.35	V	
V _{OH}	High-Level Output Voltage	I _{SOURCE} =3.0mA	2.65	2.85		V	
t _{PLH}	Propagation Delay (Turn-On)	Overdrive=20mV, C _L =15pF		0.45		μs	
t _{PHL}	Propagation Delay (Turn-Off)	Overdrive=20mV, C _L =15pF		0.47		μs	
t _{TLH}	Decrease Time Outsit Discust 19:44)	0 -50-5		6.1			
t _{THL}	Response Time, Output Rise/Fall ⁽⁴⁾	C _L =50pF		6.2		ns	

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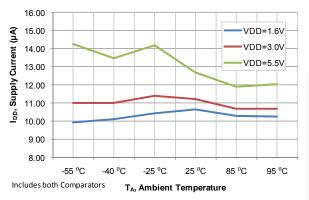
Electrical Characteristics

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
V _{DD} =1.6V, V _S	_{SS} =GND, and T _A =+25°C		•			
V _{HYS}	Input Hysteresis	V_{CM} =0.5 V_{DD}		3.5		mV
V _{IO}	Input Offset Voltage ⁽²⁾	V _{CM} =0.5V _{DD}	-15	±1	+15	mV
I _{IO}	Input Offset Current			10		pA
I _I	Input Bias Current			10		pА
V_{CM}	Common Mode Input Voltage		V _{SS}		V_{DD}	V
CMRR	Common Mode Rejection Ratio ⁽³⁾	V _{CM} =V _{DD}		56		dB
I _{DD}	Supply Current(x) Per Comparator			5	13	μA
PSRR	Power Supply Rejection Ratio ⁽³⁾	ΔV_{DD} =0.5V	45	70		dB
1	Output Short Circuit Current	V _O =V _{DD}		5.5		mA
los		V _O =V _{SS}		7.5		
V _{OL}	Low-Level Output Voltage	I _{SINK} =1.0mA		0.15	0.25	V
V _{OH}	High-Level Output Voltage	I _{SOURCE} =1.0mA	1.35	1.50		V
t _{PLH}	Propagation Delay (Turn-On)	Overdrive=20mV, C _L =15pF		0.52		μs
t _{PHL}	Propagation Delay (Turn-Off)	Overdrive=20mV, C _L =15pF		0.54		μs
t _{TLH}	Decrease Time Output Dis- (F-11(4)	0. 50.5		16.5		
t _{THL}	Response Time, Output Rise/Fall ⁽⁴⁾	C _L =50pF		13.0		ns

- Differential input switching level is guaranteed at the minimum or maximum offset voltage, minus or plus half the maximum hysteresis voltage.

 Guaranteed by design and characterization data
 Input signal: 1kHz, square-wave signal with 10ns edge rate.

Typical Performance Characteristics



900 800 1.6 VDD 700 3.0 VDD 600 <u>{</u> 5.5 VDD 500 ၁ 400 300 200 100 0.01 Temp. =25C 0.1 10 100 1000 Frequency (Khz) C_L = 15pF

Figure 4. Supply Current vs. Temperature

16 14 I_{DD}, Supply Current (μA) 12 8 -40 °C 6 25 °C 4 85 °C O 1.5 2.5 3 3.5 * Data includes V_{DD}, Supply Voltage (V) both comparators

Figure 5. Supply Current vs. Output Transition Frequency

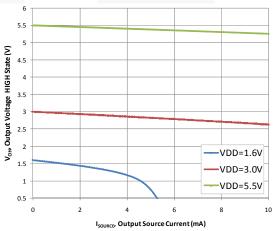


Figure 6. Supply Current vs. Supply Voltage

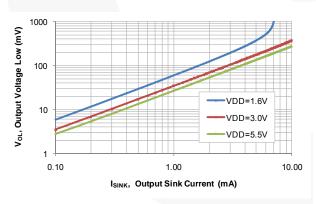


Figure 7. Output HIGH vs. Output Drive Current

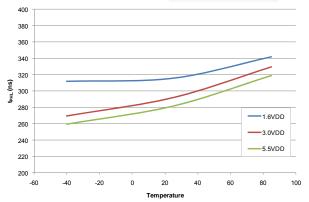
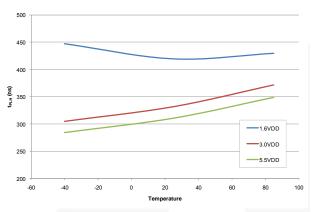


Figure 8. Output LOW vs. Output Drive Current

Figure 9. Propagation Delay (t_{PHL}) vs. Temperature

Typical Performance Characteristics (Continued)



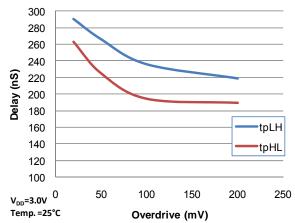


Figure 10.Propagation Delay (t_{PLH}) vs. Temperature

Figure 11. Propagation Delay vs. Input Overdrive

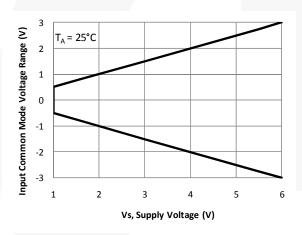
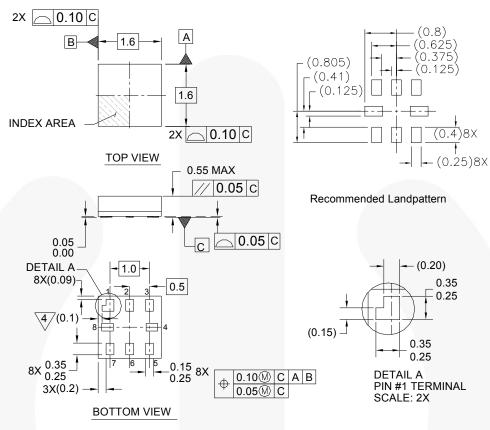


Figure 12. Input Common Mode Voltage Range vs. Supply Voltage

Figure 13. Power-Up Delay

Physical Dimensions



Notes:

- 1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y.14M-1994
- 4/PIN 1 FLAG, END OF PACKAGE OFFSET
- 5. DRAWING FILE NAME: MKT-MAC08AREV4

MAC08AREV4

Figure 14. 8-Lead, MicroPak™ 1.6mm Wide

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